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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of: Pas

Docket No.: TI-22398.1

Serial No.: 10/656,312

Art Unit: 1765

Filed: 09/05/2003

Examiner: Ahmed, Shamim

Title: System and Method for Integrating Oxide Removal and Processing Of a Semiconductor Wafer

AMENDMENT UNDER 37 C.F.R. §1.111

December 8, 2004

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Commissioner:

MAILING CERTIFICATE UNDER 37 C.F.R. §1.8(A)

I hereby certify that the above correspondence is being deposited with the U.S. Postal Service on 12-8-04 as First Class Mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450

Karen Vertz
Karen Vertz

12-8-04

Date

In response to the Office Action, dated 11/30/2004, in the above-identified patent application, please accept the following amendments. They are respectfully submitted as a full and complete response to that Action. Charge any required fees to the deposit account of Texas Instruments Incorporated, Account No. 20-0668.